# **Triacs**

# **Silicon Bidirectional Thyristors**

Triacs are designed primarily for full-wave ac control applications, such as light dimmers, motor controls, heating controls and power supplies.

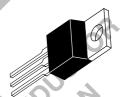
- Blocking Voltage to 800 Volts
- Glass Passivated Junctions for Greater Parameter Uniformity and Stability
- TO-220 Construction Low Thermal Resistance, High Heat Dissipation and Durability
- Gate Triggering Guaranteed in Three Modes (MAC218 Series) or Four Modes (MAC218A Series)



# ON Semiconductor®

http://onsemi.com





CASE 221A-04 (TO-220AB) STYLE 4

## MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted.)

Rating	Symbol	Value	Unit
Peak Repetitive Off-State Voltage <sup>(1)</sup> (Gate Open, T <sub>J</sub> = 25 to 125°C)  MAC218-4, MAC218A4  MAC218-6, MAC218A6  MAC218-8, MAC218A8  MAC218-10, MAC218A10	V <sub>DRM</sub>	200 400 600 800	Volts
On-State Current RMS (Conduction Angle = 360°, T <sub>C</sub> = +80°C)	I <sub>T(RMS)</sub>	8	Amps
Peak Non-repetitive Surge Current (One Full Cycle, 60 Hz, T <sub>C</sub> = 80°C, preceded and followed by rated current)	I <sub>TSM</sub>	100	Amps
Fusing Current (t = 8.3 ms)	I <sup>2</sup> t	40	A <sup>2</sup> s
Peak Gate Power (T <sub>C</sub> = +80°C, Pulse Width = 2 μs)	P <sub>GM</sub>	16	Watts
Average Gate Power $(T_C = +80^{\circ}C, t = 8.3 \text{ ms})$	P <sub>G(AV)</sub>	0.35	Watt
Peak Gate Trigger Current (Pulse Width = 1 μs)	I <sub>GTM</sub>	4	Amps
Operating Junction Temperature Range	TJ	-40 to +125	°C
Storage Temperature Range	T <sub>stg</sub>	-40 to +150	°C

<sup>1..</sup> V<sub>DRM</sub> for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

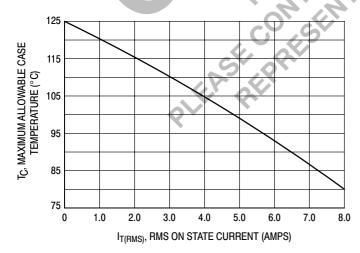
#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{ heta JC}$	2.2	°C/W

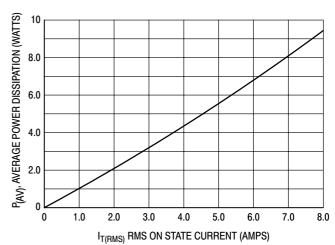
### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted.)

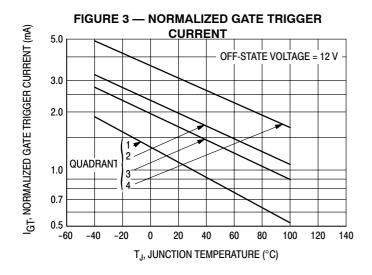
Characteristic	Symbol	Min	Тур	Max	Unit
Peak Blocking Current $(V_D = Rated \ V_{DRM}, \ gate \ open) \qquad T_J = 25^{\circ}C \\ T_J = 125^{\circ}C$	I <sub>DRM</sub>	_	_	10 2	μA mA
Peak On-State Voltage (Either Direction) (I <sub>TM</sub> = 11.3 A Peak; Pulse Width = 1 to 2 ms, Duty Cycle < 2%)	V <sub>TM</sub>	_	1.7	2	Volts
Gate Trigger Current (Continuous dc) $(V_D=12\ Vdc,\ R_L=12\Omega)$ Trigger Mode $MT2(+),\ Gate(+);\ MT2(+),\ Gate(-);\ MT2(-),\ Gate(-)$ $MT2(-),\ Gate(+)\ "A"\ SUFFIX\ ONLY$	lgt	<u> </u>	_ _	50 75	mA
Gate Trigger Voltage (Continuous dc) (Main Terminal Voltage = 12 Vdc, $R_L$ = 100 Ohms) MT2(+), $G(+)$ MT2(+), $G(-)$ MT2(-), $G(-)$ MT2(-), $G(-)$ MT2(-), $G(+)$ "A" SUFFIX ONLY (Main Terminal Voltage = Rated $V_{DRM}$ , $R_L$ = 10 k $\Omega$ , $T_J$ = +125°C) MT2(+), $G(+)$ ; MT2(-), $G(-)$ ; MT2(+), $G(-)$ MT2(-), $G(+)$ "A" SUFFIX ONLY	V <sub>GT</sub>	- - - - 0.2 0.2	0.9 0.9 1.1 1.4	2 2 2 2.5	Volts
Holding Current (Either Direction) (V <sub>D</sub> = 24 Vdc, Gate Open, Initiating Current = 200 mA)	BOLLINI	RITI	_	50	mA
Critical Rate of Rise of Commutating Off-State Voltage (V <sub>D</sub> = Rated V <sub>DRM</sub> , I <sub>TM</sub> = 11.3 A, Commutating di/dt = 4.1 A/ms, Gate Unenergized, T <sub>C</sub> = 80°C)	dv/dt(c)	_	5	_	V/μs
Critical Rate of Rise of Off-State Voltage ( $V_D$ = Rated $V_{DRM}$ , Exponential Voltage Rise, Gate Open, $T_J$ = 125°C)	dv/dt	_	100	_	V/μs

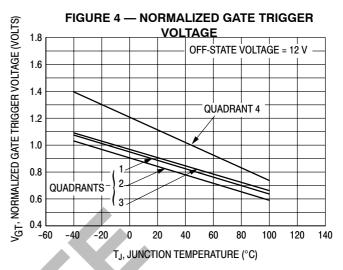
# FIGURE 1 — CURRENT DERATING



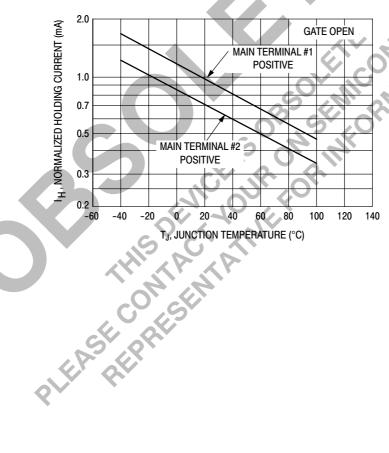
#### FIGURE 2 — POWER DISSIPATION







## FIGURE 5 — NORMALIZED HOLDING CURRENT



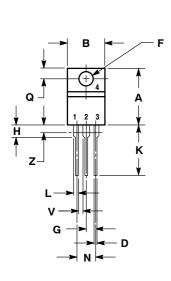
#### PACKAGE DIMENSIONS

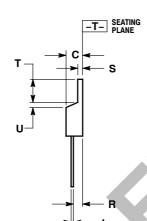
#### **CASE 221A-04** (TO-220AB)

STYLE 4:

PIN 1. MAIN TERMINAL 1 MAIN TERMINAL 2

GATE MAIN TERMINAL 2





NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  - CONTROLLING DIMENSION: INCH.
- DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIMETERS	
MIC	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.014	0.022	0.36	0.55
K	0.500	0.562	12.70	14.27
L	0.045	0.055	1.15	1.39
N <sub>l</sub>	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T.	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045		1.15	
Z		0.080		2.04

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